



60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)} max	Ι _D T _C = +25°C
60V	40mΩ @ V _{GS} = 10V	20A
	50mΩ @ V _{GS} = 4.5V	16A

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions
- Backlighting

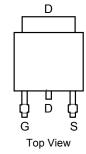
Features

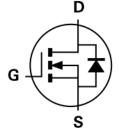
- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.33 grams (approximate)







Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN6040SK3-13	TO252	2,500/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

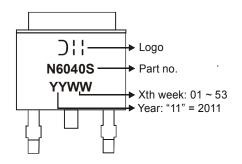
 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	60	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5) V_{GS} = -10V	Steady State	T _C = +25°C T _C = +100°C	ID	20 13	A
Maximum Body Diode Forward Current (Note 5)	ls	4	A		
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	30	A
Avalanche Current (Note 6)			I _{AR}	14.2	A
Avalanche Energy (Note 6)			E _{AR}	10	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 5)	T _C = +25°C	Р	42	w	
Total Power Dissipation (Note 5)	T _C = +100°C	PD	17		
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	44	°C/W		
Thermal Resistance, Junction to Case (Note 5)		R _{0JC}	3	°C/W	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	V _{GS} = 0V, I _D = 250µA
Zero Gate Voltage Drain Current	I _{DSS}	—	—	1	μA	V _{DS} = 60V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V_{GS} = ±20V, V_{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	1	—	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	_	_	30	40	mΩ	V _{GS} = 10V, I _D = 20A
Static Drain-Source On-Resistance	R _{DS(ON)}	_	35	50	1115.2	V _{GS} = 4.5V, I _D = 12A
Diode Forward Voltage	V _{SD}		0.7	1.2	V	V _{GS} = 0V, I _S = 1A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		1287	_		V _{DS} = 25V, V _{GS} = 0V f = 1.0MHz
Output Capacitance	Coss	_	57	_	pF	
Reverse Transfer Capacitance	Crss	_	44	_		
Gate Resistance	R _G		1.2	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = 10V)	Qg		22.4	_		
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	10.4	_	nC	
Gate-Source Charge	Qgs		4.9	_	nc	$V_{DS} = 30V, I_D = 4.3A$
Gate-Drain Charge	Q _{gd}		3.0	_		
Turn-On Delay Time	t _{D(on)}		6.6	—		V _{GS} = 10V, V _{DD} = 30V, R _G = 6Ω,
Turn-On Rise Time	tr		8.1	_	nS	
Turn-Off Delay Time	t _{D(off)}	—	20.1	_	115	I _D = 4.3A
Turn-Off Fall Time	tf		4.0	—	1	
Body Diode Reverse Recovery Time	t _{rr}	—	18	—	nS	I _S = 4.3A, dl/dt = 100A/µs
Body Diode Reverse Recovery Charge	Qrr	—	11.9	_	nC	I _S = 4.3A, dl/dt = 100A/µs

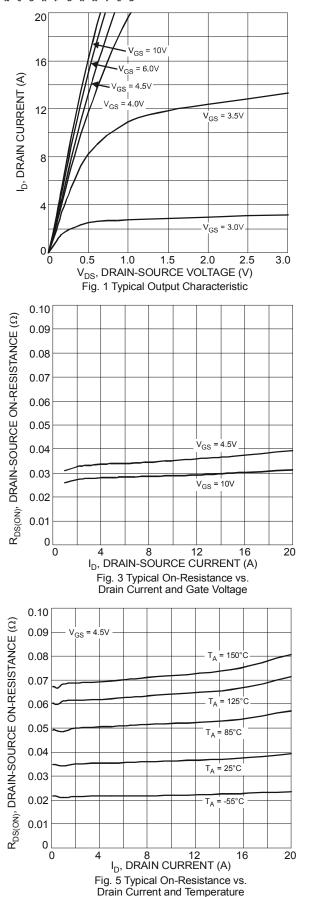
5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout. 6. UIS in production with L = 0.1mH, T_J = +25°C. 7. Short duration pulse test used to minimize self-heating effect.

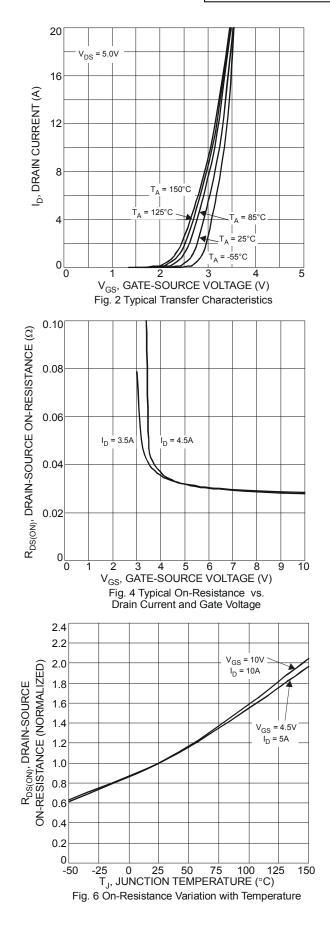
8. Guaranteed by design. Not subject to product testing.

Notes:

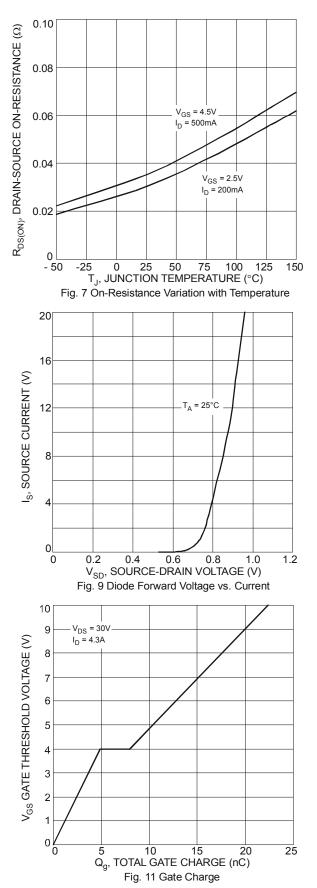
DMN6040SK3

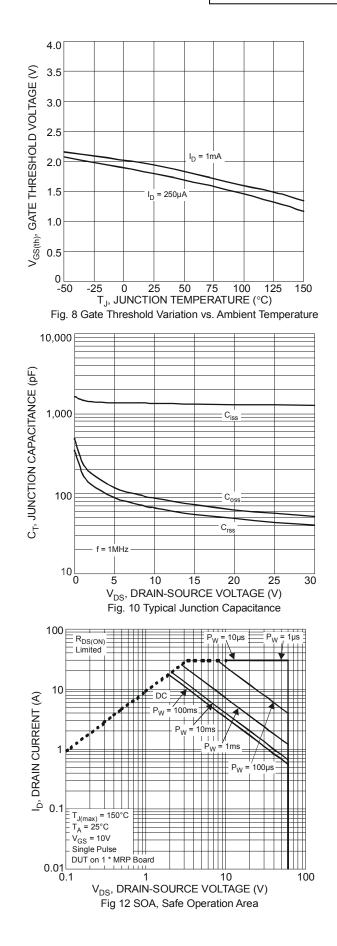








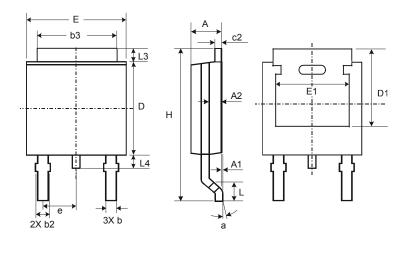






Package Outline Dimensions

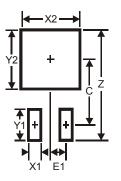
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



TO252					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
c2	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
Е	6.45	6.70	6.58		
E1	4.32	_	-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	_		
All	All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
Z	11.6		
X1	1.5		
X2	7.0		
Y1	2.5		
Y2	7.0		
C	6.9		
E1	2.3		



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